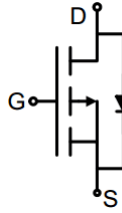
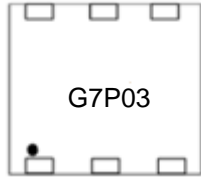
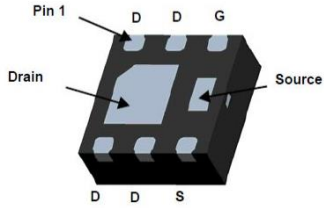


## P-Channel Enhancement Mode Power MOSFET

<p><b>Description</b></p> <p>The G7P03D2 uses advanced trench technology to provide excellent <math>R_{DS(ON)}</math>, low gate charge. It can be used in a wide variety of applications.</p> <p><b>General Features</b></p> <ul style="list-style-type: none"> <li>● <math>V_{DS}</math> -30V</li> <li>● <math>I_D</math> (at <math>V_{GS} = -10V</math>) -7A</li> <li>● <math>R_{DS(ON)}</math> (at <math>V_{GS} = -10V</math>) &lt; 20.5mΩ</li> <li>● <math>R_{DS(ON)}</math> (at <math>V_{GS} = -4.5V</math>) &lt; 26mΩ</li> <li>● 100% Avalanche Tested</li> <li>● RoHS Compliant</li> </ul> <p><b>Application</b></p> <ul style="list-style-type: none"> <li>● Synchronous Rectification in SMPS or LED Driver</li> <li>● UPS</li> <li>● Motor Control</li> <li>● BMS</li> <li>● High Frequency Circuit</li> </ul>		 <p>Schematic diagram</p>  <p>Marking and pin assignment</p>  <p>DFN2*2-6L</p>	
<b>Device</b>	<b>Package</b>	<b>Marking</b>	<b>Packaging</b>
G7P03D2	DFN2*2-6L	G7P03	3000pcs/Reel

### Absolute Maximum Ratings $T_C = 25^{\circ}C$ , unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-30	V
Continuous Drain Current	$I_D$	-7	A
Pulsed Drain Current (note1)	$I_{DM}$	-28	A
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Power Dissipation	$P_D$	1.3	W
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 To 150	$^{\circ}C$

### Thermal Resistance

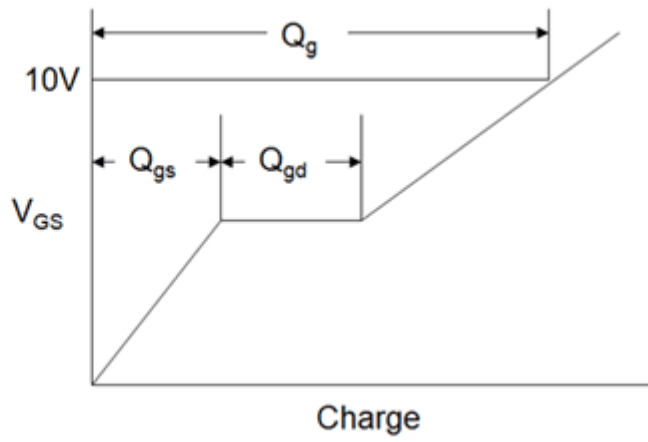
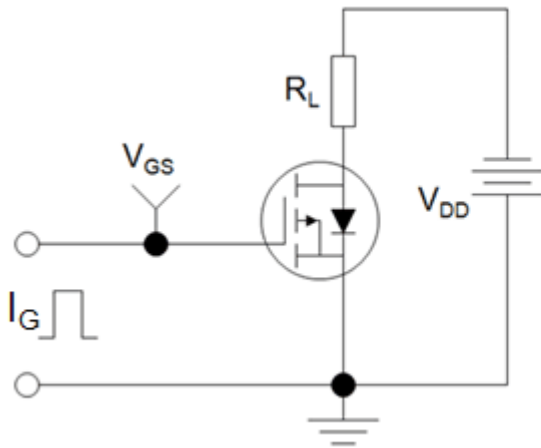
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient (note3)	$R_{thJA}$	95	$^{\circ}C/W$

Specifications $T_J = 25^\circ\text{C}$ , unless otherwise noted						
Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
<b>Static Parameters</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-30	--	--	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -30V, V_{GS} = 0V$	--	--	-1	$\mu A$
Gate-Source Leakage	$I_{GSS}$	$V_{GS} = \pm 20V$	--	--	$\pm 100$	nA
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-0.5	-0.9	-1.1	V
Drain-Source On-Resistance (note2)	$R_{DS(on)}$	$V_{GS} = -10V, I_D = -1A$	--	17	20.5	m $\Omega$
		$V_{GS} = -4.5V, I_D = -1A$	--	21	26	
Forward Transconductance	$g_{FS}$	$V_{DS} = -5V, I_D = -2A$	--	10	--	S
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0V,$ $V_{DS} = -15V,$ $f = 1.0\text{MHz}$	--	1900	--	pF
Output Capacitance	$C_{oss}$		--	230	--	
Reverse Transfer Capacitance	$C_{rss}$		--	150	--	
Total Gate Charge	$Q_g$	$V_{DD} = -15V,$ $I_D = -4A,$ $V_{GS} = -4.5V$	--	19	--	nC
Gate-Source Charge	$Q_{gs}$		--	4	--	
Gate-Drain Charge	$Q_{gd}$		--	6	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = -15V,$ $I_D = -4A,$ $R_G = 6\Omega$	--	14	--	ns
Turn-on Rise Time	$t_r$		--	6	--	
Turn-off Delay Time	$t_{d(off)}$		--	60	--	
Turn-off Fall Time	$t_f$		--	24	--	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Body Diode Current	$I_S$	$T_C = 25^\circ\text{C}$	--	--	-7	A
Body Diode Voltage	$V_{SD}$	$T_J = 25^\circ\text{C}, I_{SD} = -1A, V_{GS} = 0V$	--	--	-1.2	V

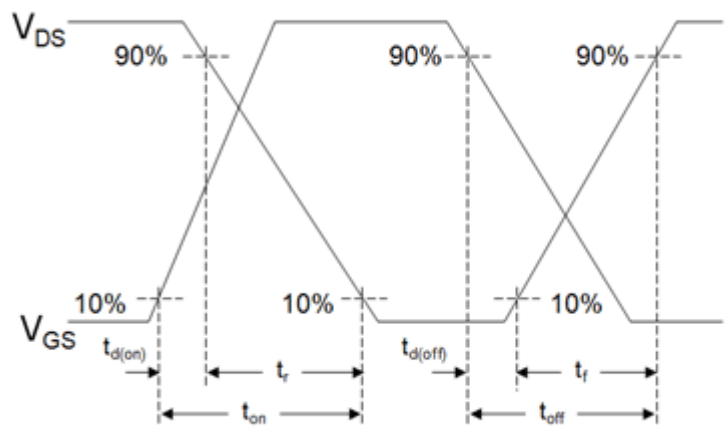
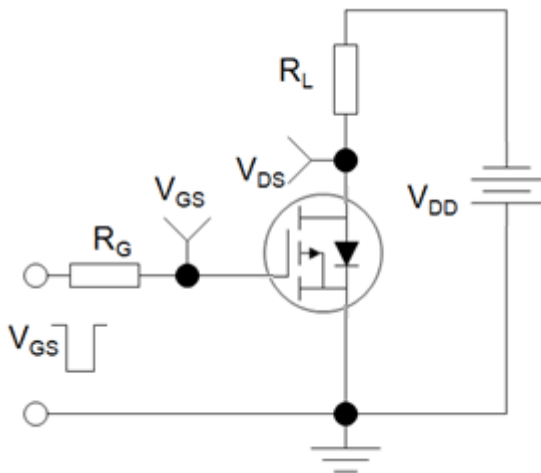
**Notes**

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Surface mounted on 1 in<sup>2</sup> copper pad of FR4 board

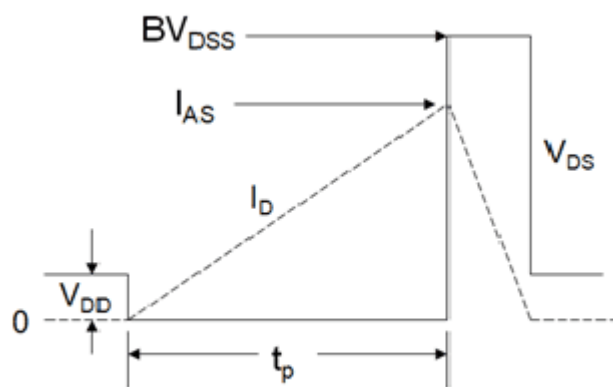
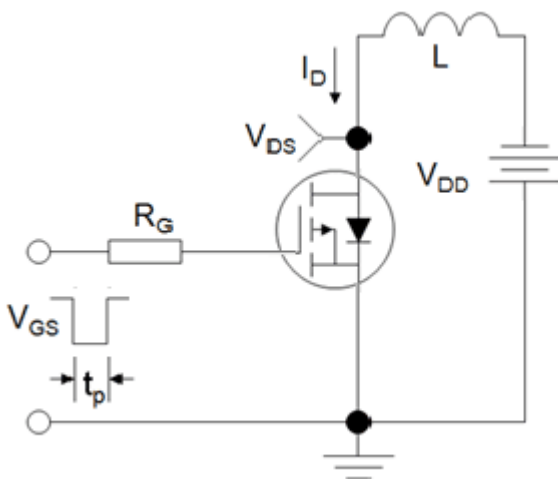
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



Typical Characteristics  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Figure 1. Output Characteristics

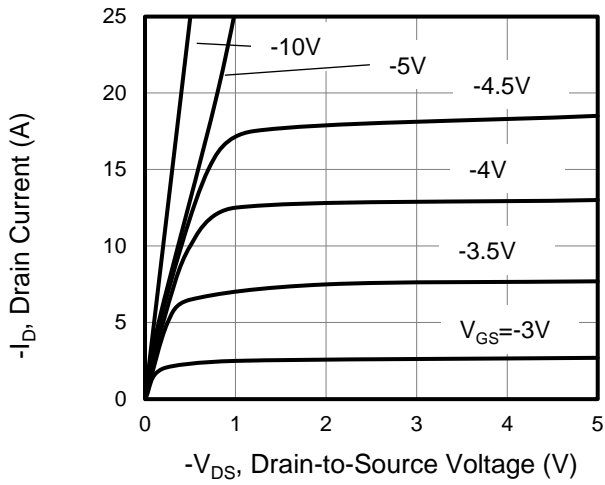


Figure 2. Transfer Characteristics

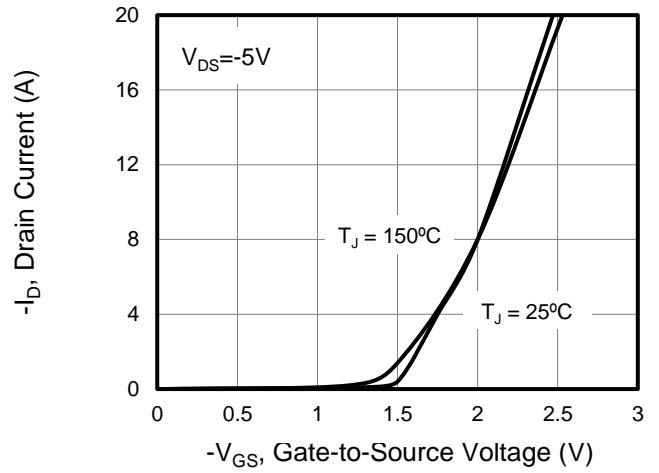


Figure 3. Drain Source On Resistance

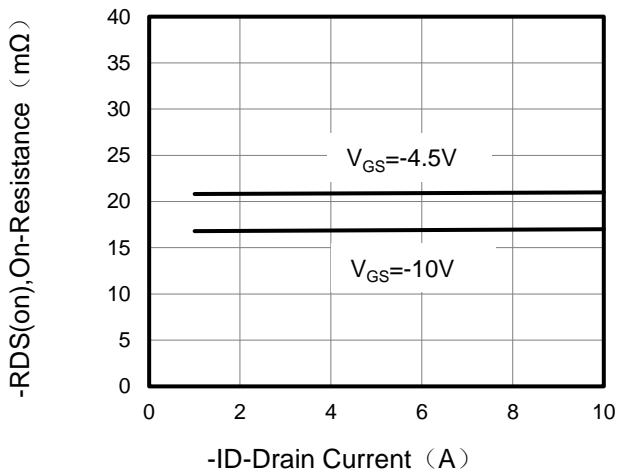


Figure 4. Gate Charge

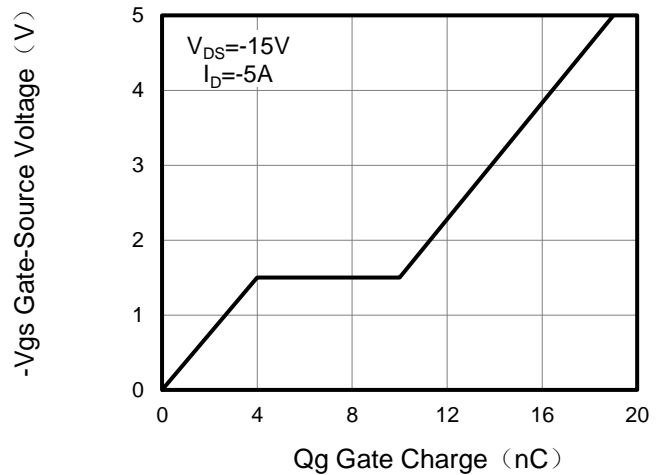


Figure 5. Capacitance vs Vds

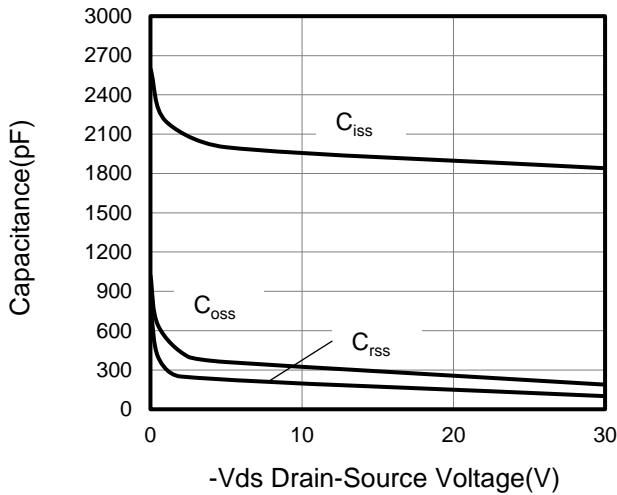
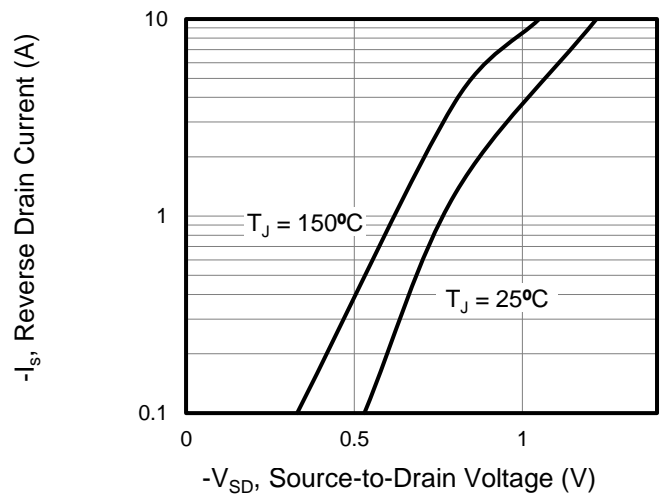


Figure 6. Source-Drain Diode Forward



Typical Characteristics  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Figure 7. Drain-Source On-Resistance

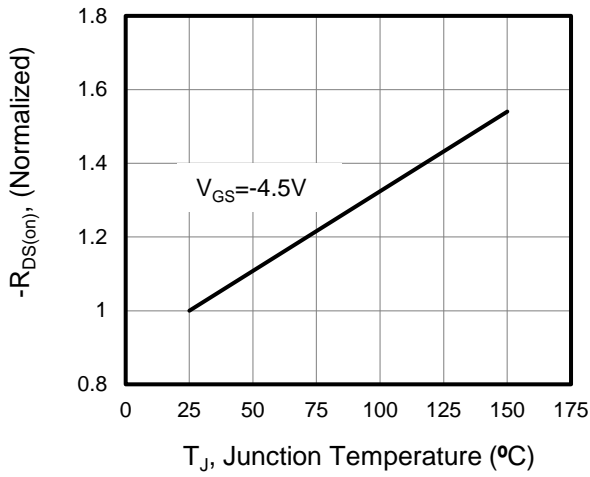


Figure 8. Safe Operation Area

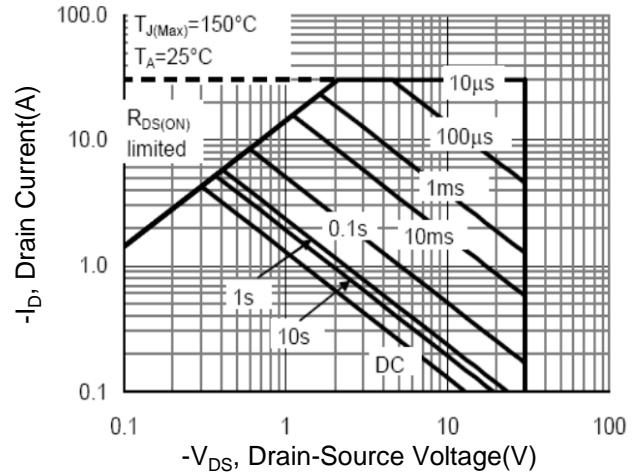
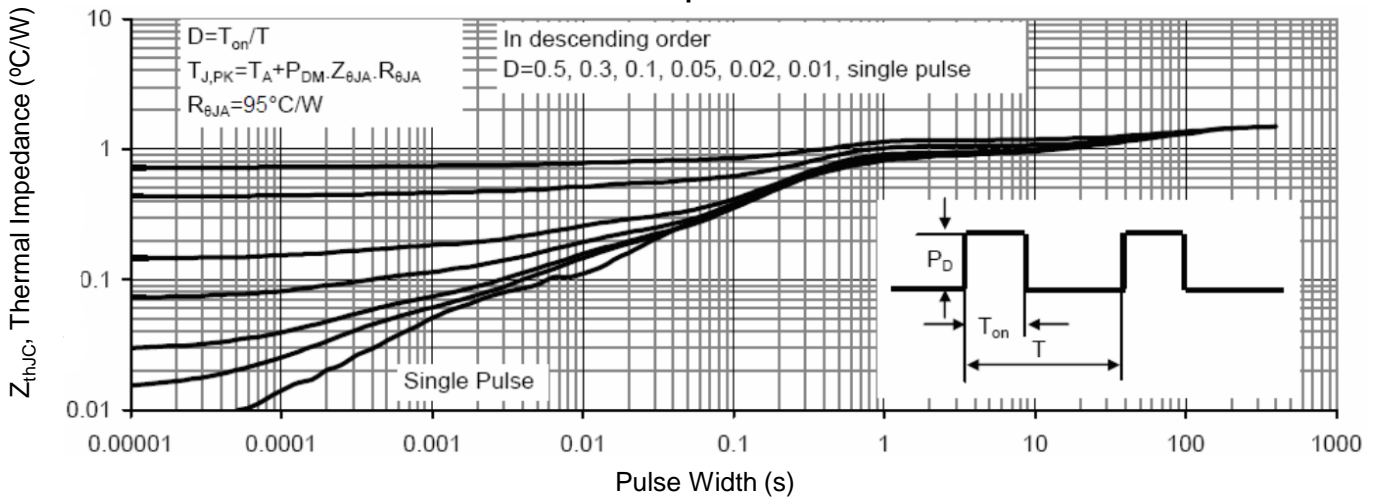
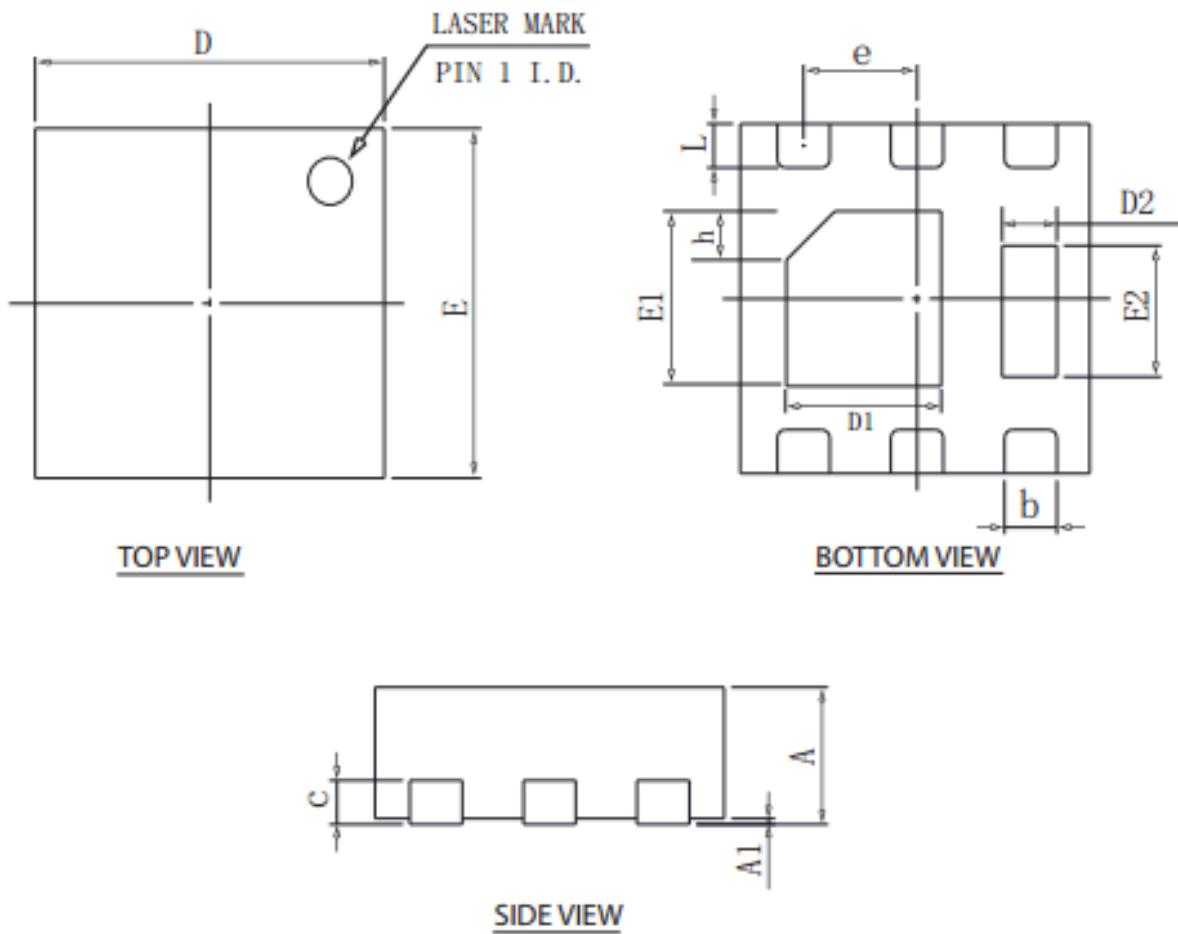


Figure 9. Normalized Maximum Transient Thermal Impedance



DFN2×2-6L Package Information



COMMON DIMENSIONS

SYMBOL	mm		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	NA	0.02	0.05
b	0.20	0.27	0.34
c	0.18	0.20	0.25
D	1.95	2.00	2.07
E	1.95	2.00	2.07
D1	0.80	0.90	1.00
E1	0.90	1.00	1.10
D2	0.20	0.30	0.40
E2	0.65	0.75	0.85
L	0.20	0.25	0.35
h	0.20	0.25	0.30
e	0.65BSC		